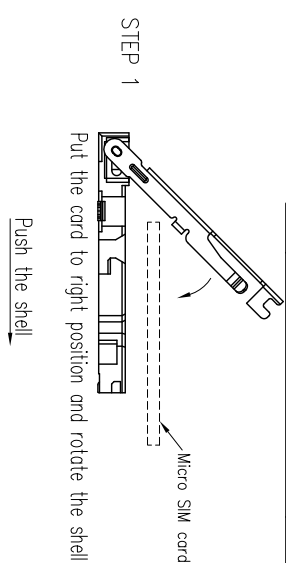


Micro SIM card  
Thickness: 0.76±0.08

RECOMMENDED PCB LAYOUT(TOP VIEW)  
TOLERANCE: ±0.05

REV	ECN NO	OR DESCRIPTION	REVISED	DATE
A		PRODUCT RELEASE	Hogem, Hu	2012.06.29
B	ECN C140043	UPDATE DRAWING	ZLS	2014.7.4



**SPECIFICATIONS:**

- ELECTRICAL CHARACTERISTICS:
  - CURRENT RATING: 1A
  - DIELECTRIC WITHSTANDING VOLTAGE: 500V R.M.S MIN;
  - INSULATION RESISTANCE: 1000MΩ MIN.
  - CONTACT RESISTANCE: 30mΩ MAX.(INITIAL)
- LIFE TEST: 2500 CYCLES.
- OTHER GENERAL SPEC. TO REFER "ZSM2011-000111F\_SPEC".
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT: ©
- HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING: ©
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.
- PACKAGING: TAPE & REEL.



D	Metal Ear	2	COPPY ALLOY T=0.15	GOLD FLASH SOLDER AREA
C	Shell	1	STAINLESS STEEL T=0.2	N/A
B	Spring	8	COPPY ALLOY T=0.15	GOLD FLASH ON CONTACT AREA TIN PLATED ON SOLDER AREA
A	Housing	1	HIGH-THERMAL PLASTIC U94-V0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
UNLESS OTHERWISE SPECIFIED TOLERANCES				
Singatron Enterprise Co., Ltd. 信音企業股份有限公司				
DECIMALS: ANGLES:				
X	: ±0.5	X	: ±2°	
X,X	: ±0.3	X,X	: ±1°	
X,XX	: ±0.2			
TITLE: MICRO SIM CONNECTOR				
DMW	ZLS 14/7/11	PART NO.	ZSM2011-000111F	
CHKD	BILLY 14/7/11	SCALE	4:1	UNIT: mm
APVD	ZLS 14/7/11	SIZE: A3	SHEET1 OF 1	REV: B
CUSTOMER COPY				